



Bridgelux[®] SMD 5050 5W 24V

Product Data Sheet DS911

SMD 5050



Introduction

The Bridgelux SMD 5050 high power LED is hot-color targeted, which ensures that the LEDs fall within their specified color bin at the typical application conditions of 85°C. With its broad lumen coverage and wide range of CCT and CRI options, the SMD 5050 provides unparalleled design-in flexibility for indoor and outdoor lighting applications. The SMD 5050 is ideal as a drop-in replacement for emitters with an industry standard 5.0mm x 5.0mm footprint.

Features

- Industry-standard 5050 footprint
- 2 color bin options enable tight color control
- Hot-color targeting ensures that color is within the bin at the typical application condition of 85°C
- · 3- and 5-step MacAdam ellipse options
- · RoHS compliant and lead free
- Multiple CCT and CRI configurations for a wide range of lighting applications

Benefits

- · Lower operating and manufacturing cost
- · Ease of design and rapid go-to-market
- · Uniform consistent white light
- · Compliant with environmental standards
- · Design flexibility

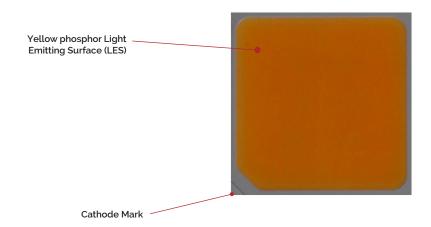


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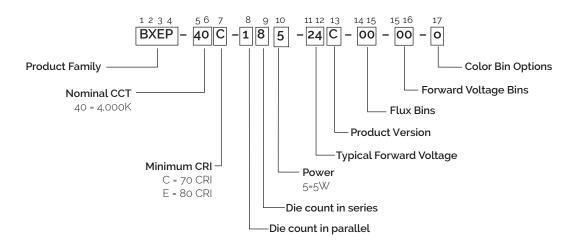
Product Feature Map

Bridgelux SMD LED products come in industry standard package sizes and follow ANSI binning standards. These LEDs are optimized for cost and performance, helping to ensure highly competitive system lumen per dollar performance while addressing the stringent efficacy and reliability standards required for modern lighting applications.



Product Nomenclature

The part number designation for Bridgelux SMD 5050 is explained as follows:



Product Selection Guide

The following product configurations are available:

Table 1: Selection Guide, Pulsed Measurement Data at 160mA (T_i=T_{so}=25°C)

Part Number ^{1,6}	Nominal CCT ²	CRI ^{3, 5}	Nominal Drive Current	Forward Voltage ^{4.5} (V)			Typical Pulsed Flux (lm)4.5	Typical Power (W)	Typical Efficacy
	(K)		(mA)	Min	Typical	Max	Flux (III)***	(W)	(uli) W)
BXEP-27C-185-24C-00-00-0	2700	70	160	23.0	24.4	26.0	647	3.9	166
BXEP-27E-185-24C-00-00-0	2700	80	160	23.0	24.4	26.0	597	3.9	153
BXEP-30C-185-24C-00-00-0	3000	70	160	23.0	24.4	26.0	666	3.9	171
BXEP-30E-185-24C-00-00-0	3000	80	160	23.0	24.4	26.0	615	3.9	158
BXEP-40C-185-24C-00-00-0	4000	70	160	23.0	24.4	26.0	709	3.9	182
BXEP-40E-185-24C-00-00-0	4000	80	160	23.0	24.4	26.0	654	3.9	168
BXEP-50C-185-24C-00-00-0	5000	70	160	23.0	24.4	26.0	709	3.9	182
BXEP-50E-185-24C-00-00-0	5000	80	160	23.0	24.4	26.0	654	3.9	168
BXEP-57C-185-24C-00-00-0	5700	70	160	23.0	24.4	26.0	702	3.9	180
BXEP-57E-185-24C-00-00-0	5700	80	160	23.0	24.4	26.0	648	3.9	166
BXEP-65C-185-24C-00-00-0	6500	70	160	23.0	24.4	26.0	702	3.9	180
BXEP-65E-185-24C-00-00-0	6500	80	160	23.0	24.4	26.0	648	3.9	166

Notes for Table 1:

- 1. The last 7 characters (including hyphens '-') refer to flux bins, forward voltage bins, and color bin options, respectively. "00-00-0" denotes the full distribution of flux, forward voltage, and 5 SDCM color.
 - Example: BXEP-40C-185-24C-00-00-0 refers to the full distribution of flux, forward voltage, and color within a 4000K 5-step ANSI standard chromaticity region with a minimum of 70CRI, 1x8 die configuration, 5w power, 24.4V typical forward voltage.
- 2. Product CCT is hot targeted at T_{so} = 85°C. Nominal CCT as defined by ANSI C78.377-2011.
- 3. Listed CRIs are minimum values and include test tolerance.
- 4. Products tested under pulsed condition (10ms pulse width) at nominal drive current where T_i=T_{so}=25°C.
- 5. Bridgelux maintains a ±7.5% tolerance on luminous flux measurements, ±0.1V tolerance on forward voltage measurements, and ±2 tolerance on CRI measurements for the SMD 5050 .
- 6. Refer to Table 6 and Table 7 for Bridgelux SMD 5050 Luminous Flux Binning and Forward Voltage Binning information.

Product Selection Guide

The following product configurations are available:

Table 2: Selection Guide, Stabilized DC Performance ($T_{so} = 85^{\circ}C$)^{6,7}

Part Number	Nominal CCT ¹	ominal CCT¹ CRI².3		Forward Voltage³ (V)			Typical DC Flux	Typical DC Power	Typical DC Effi- cacy (lm/W)
			(mA)	Min	Typical	Max	(um) ³	(W)	Cacy (IIII/ W)
BXEP-27C-185-24C-00-00-0	2700	70	160	22.6	24.0	25.5	592	3.8	154
BXEP-27E-185-24C-00-00-0	2700	80	160	22.6	24.0	25.5	546	3.8	142
BXEP-30C-185-24C-00-00-0	3000	70	160	22.6	24.0	25.5	609	3.8	159
BXEP-30E-185-24C-00-00-0	3000	80	160	22.6	24.0	25.5	562	3.8	147
BXEP-40C-185-24C-00-00-0	4000	70	160	22.6	24.0	25.5	648	3.8	169
BXEP-40E-185-24C-00-00-0	4000	80	160	22.6	24.0	25.5	598	3.8	156
BXEP-50C-185-24C-00-00-0	5000	70	160	22.6	24.0	25.5	648	3.8	169
BXEP-50E-185-24C-00-00-0	5000	80	160	22.6	24.0	25.5	598	3.8	156
BXEP-57C-185-24C-00-00-0	5700	70	160	22.6	24.0	25.5	642	3.8	167
BXEP-57E-185-24C-00-00-0	5700	80	160	22.6	24.0	25.5	592	3.8	155
BXEP-65C-185-24C-00-00-0	6500	70	160	22.6	24.0	25.5	642	3.8	167
BXEP-65E-185-24C-00-00-0	6500	80	160	22.6	24.0	25.5	592	3.8	155

Notes for Table 2:

- 1. The last 7 characters (including hyphens '-') refer to flux bins, forward voltage bins, and color bin options, respectively. "00-00-0" denotes the full distribution of flux, forward voltage, and 5 SDCM color.
 - EExample: BXEP-40C-185-24C-00-00-0 refers to the full distribution of flux, forward voltage, and color within a 4000K 5-step ANSI standard chromaticity region with a minimum of 70CRI, 1x8 die configuration, 5w power, 24.4V typical forward voltage.
- 2. Product CCT is hot targeted at T_{sp} = 85°C. Nominal CCT as defined by ANSI C78.377-2011.
- 3. Listed CRIs are minimum values and include test tolerance.
- 4. Bridgelux maintains a ±7.5% tolerance on luminous flux measurements, ±0.1V tolerance on forward voltage measurements, and ±2 tolerance on CRI measurements for the SMD 5050.
- 5. Refer to Table 6 and Table 7 for Bridgelux SMD 5050 Luminous Flux Binning and Forward Voltage Binning information.
- 6. Typical stabilized DC performance values are provided as reference only and are not a guarantee of performance.
- 7. Typical performance is estimated based on operation under DC (direct current) with LED emitter mounted onto a heat sink with thermal interface material and the solder point temperature maintained at 85°C. Based on Bridgelux test setup, values may vary depending on the thermal design of the luminaire and/or the exposed environment to which the product is subjected.

Performance at Commonly Used Drive Currents

SMD 5050 LEDs are tested to the specifications shown using the nominal drive currents in Table 1. SMD 5050 may also be driven at other drive currents dependent on specific application design requirements. The performance at any drive current can be derived from the current vs. voltage characteristics shown in Figure 2 and the relative luminous flux vs. current characteristics shown in Figure 3. The performance at commonly used drive currents is summarized in Table 3.

Table 3: Performance at Commonly Used Drive Currents

Part Number	CRI	Drive Current¹ (mA)	Typical V _f T _{sp} = 25°C (V)	Typical Power T _{sp} = 25°C (W)	Typical Pulsed Flux ² T _{sp} = 25°C (lm)	Typical DC Flux³ T _{sp} = 85°C (lm)	Typical Efficacy T _{sp} = 25°C (lm/W)
		45	21.9	1.0	194	181	197
		90	22.9	2.1	379	351	183
		135	23.9	3.2	554	508	172
BXEP-27C-185-24C-00-00-0	70	160	24.4	3.9	647	592	166
		180	24.8	4.5	720	656	161
		200	25.2	5.0	792	718	157
		250	26.1	6.5	962	867	147
		45	21.9	1.0	179	167	182
		90	22.9	2.1	349	324	169
	80	135	23.9	3.2	511	469	158
BXEP-27E-185-24C-00-00-0		160	24.4	3.9	597	546	153
		180	24.8	4.5	665	605	149
		200	25.2	5.0	730	663	145
		250	26.1	6.5	888	800	136
		45	21.9	1.0	200	186	202
		90	22.9	2.1	390	361	189
		135	23.9	3.2	570	523	177
BXEP-30C-185-24C-00-00-0	70	160	24.4	3.9	666	609	171
		180	24.8	4.5	741	675	166
		200	25.2	5.0	815	739	162
		250	26.1	6.5	990	892	152
		45	21.9	1.0	184	172	187
		90	22.9	2.1	360	334	174
	80	135	23.9	3.2	526	483	163
BXEP-30E-185-24C-00-00-0		160	24.4	3.9	615	562	158
		180	24.8	4.5	685	624	153
		200	25.2	5.0	752	683	149
		250	26.1	6.5	915	824	140

Notes for Table 3:

- 1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.
- 2. Bridgelux maintains a \pm 7.5% tolerance on flux measurements.
- 3. Typical stabilized DC performance values are provided as reference only and are not a guarantee of performance.

Performance at Commonly Used Drive Currents

SMD 5050 LEDs are tested to the specifications shown using the nominal drive currents in Table 1. SMD 5050 may also be driven at other drive currents dependent on specific application design requirements. The performance at any drive current can be derived from the current vs. voltage characteristics shown in Figure 2 and the relative luminous flux vs. current characteristics shown in Figure 3. The performance at commonly used drive currents is summarized in Table 3.

Table 3: Performance at Commonly Used Drive Currents

Part Number	CRI	Drive Current¹ (mA)	Typical V _f T _{sp} = 25°C (V)	Typical Power T _{sp} = 25°C (W)	Typical Pulsed Flux ² T _{sp} = 25°C (lm)	Typical DC Flux³ T _{sp} = 85°C (lm)	Typical Efficacy T _{sp} = 25°C (lm/W)
		45	21.9	1.0	213	199	216
		90	22.9	2.1	415	385	201
		135	23.9	3.2	607	557	188
BXEP-40C-185-24C-00-00-0	70	160	24.4	3.9	709	648	182
		180	24.8	4.5	789	719	177
		200	25.2	5.0	867	787	172
		250	26.1	6.5	1054	950	161
		45	21.9	1.0	196	183	199
		90	22.9	2.1	383	355	185
	80	135	23.9	3.2	560	513	174
BXEP-40E-185-24C-00-00-0		160	24.4	3.9	654	598	168
		180	24.8	4.5	728	663	163
		200	25.2	5.0	800	726	159
		250	26.1	6.5	973	876	149
		45	21.9	1.0	213	199	216
		90	22.9	2.1	415	385	201
		135	23.9	3.2	607	557	188
BXEP-50C-185-24C-00-00-0	70	160	24.4	3.9	709	648	182
		180	24.8	4.5	789	719	177
		200	25.2	5.0	867	787	172
		250	26.1	6.5	1054	950	161
		45	21.9	1.0	196	183	199
		90	22.9	2.1	383	355	185
		135	23.9	3.2	560	513	174
BXEP-50E-185-24C-00-00-0	80	160	24.4	3.9	654	598	168
		180	24.8	4.5	728	663	163
		200	25.2	5.0	800	726	159
		250	26.1	6.5	973	876	149

Notes for Table 3:

- 1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.
- 2. Bridgelux maintains a ± 7.5% tolerance on flux measurements.
- 3. Typical stabilized DC performance values are provided as reference only and are not a guarantee of performance.

Performance at Commonly Used Drive Currents

SMD 5050 LEDs are tested to the specifications shown using the nominal drive currents in Table 1. SMD 5050 may also be driven at other drive currents dependent on specific application design requirements. The performance at any drive current can be derived from the current vs. voltage characteristics shown in Figure 2 and the relative luminous flux vs. current characteristics shown in Figure 3. The performance at commonly used drive currents is summarized in Table 3.

Table 3: Performance at Commonly Used Drive Currents

Part Number	CRI	Drive Current¹ (mA)	Typical V _f T _{sp} = 25°C (V)	Typical Power T _{sp} = 25°C (W)	Typical Pulsed Flux ² T _{sp} = 25°C (lm)	Typical DC Flux³ T _{sp} = 85°C (lm)	Typical Efficacy T _{sp} = 25°C (lm/W)
		45	21.9	1.0	210	197	213
		90	22.9	2.1	411	381	199
		135	23.9	3.2	601	551	186
BXEP-57C-185-24C-00-00-0	70	160	24.4	3.9	702	642	180
		180	24.8	4.5	781	712	175
		200	25.2	5.0	859	779	170
		250	26.1	6.5	1044	941	160
		45	21.9	1.0	194	181	197
		90	22.9	2.1	379	352	184
	80	135	23.9	3.2	555	509	172
BXEP-57E-185-24C-00-00-0		160	24.4	3.9	648	592	166
		180	24.8	4.5	721	657	162
		200	25.2	5.0	793	719	157
		250	26.1	6.5	964	868	148
		45	21.9	1.0	210	197	213
		90	22.9	2.1	411	381	199
		135	23.9	3.2	601	551	186
BXEP-65C-185-24C-00-00-0	70	160	24.4	3.9	702	642	180
		180	24.8	4.5	781	712	175
		200	25.2	5.0	859	779	170
		250	26.1	6.5	1044	941	160
		45	21.9	1.0	194	181	197
		90	22.9	2.1	379	352	184
	80	135	23.9	3.2	555	509	172
BXEP-65E-185-24C-00-00-0		160	24.4	3.9	648	592	166
		180	24.8	4.5	721	657	162
		200	25.2	5.0	793	719	157
		250	26.1	6.5	964	868	148

Notes for Table 3:

- 1. Alternate drive currents in Table 3 are provided for reference only and are not a guarantee of performance.
- 2. Bridgelux maintains a \pm 7.5% tolerance on flux measurements.
- 3. Typical stabilized DC performance values are provided as reference only and are not a guarantee of performance.

Electrical Characterstics

Table 4: Electrical Characteristics

	Drive Current	Forward Voltage (V) ^{1,2}			Typical Temperature Coefficient	Typical Thermal Resistance	
Part Number	(mA)	Minimum	Typical	Maximum	of Forward Voltage ∆V,∕∆T (mV/°C)	Junction to Solder Point ⁴ R _{j-sp} (°C/W)	
BXEP-XXX-185-24C-00-00-0	160	23.0	24.4	26.0	-0.91	3.2	

Notes for Table 4:

- 1. Bridgelux maintains a tolerance of ± 0.1V on forward voltage measurements. Voltage minimum and maximum values at the nominal drive current are guaranteed by 100% test.
- 2. Products tested under pulsed condition (10ms pulse width) at nominal drive current where T_{so} = 25°C.
- 3. Thermal Resistance values based on 3000K 70CRI product.
- 4. Thermal resistance value was calculated using total electrical input power, optical power was not subtracted from input power.

Absolute Maximum Ratings

Table 5: Maximum Ratings

Parameter	Maximum Rating				
LED Junction Temperature (T _j)	125°C				
Storage Temperature	-40°C to +105°C				
Operating Solder Point Temperature (T _{Sp})	-40°C to +105°C				
Soldering Temperature	260°C or lower for a maximum of 10 seconds				
Maximum Drive Current ¹	250 mA				
Maximum Peak Pulsed Forward Current ²	300 mA				
Maximum Reverse Voltage ³	-				
Moisture Sensitivity Rating	MSL 3				
Electrostatic Discharge	2kV HBM. JEDEC-JS-001-HBM and JEDEC-JS-001-2012				

Notes for Table 5:

- 1. Maximum drive current may be limited by the solder point temperature. Please see Figure 7 for further details.
- 2. Bridgelux recommends a maximum duty cycle of 10% and pulse width of 10 ms when operating LED SMD at maximum peak pulsed current specified. Maximum peak pulsed current indicate values where LED SMD can be driven without catastrophic failures.
- 3. Light emitting diodes are not designed to be driven in reverse voltage and will not produce light under this condition, no rating is provided.

Product Bin Definitions

Table 6 lists the standard photometric luminous flux bins for Bridgelux SMD 5050 LEDs. Although several bins are listed, product availability in a particular bin varies by production run and by product performance. Not all bins are available in all CCTs.

Table 6: Luminous Flux Bin Definitions at 160mA, T_{sp} =25°C

Bin Code	Minimum	Maximum	Unit	Condition	
A9	545	590			
B1	590	635		I _F =160mA	
B2	635	685	lm		
В3	685	740			
B4	740	800			

Note for Table 6:

Table 7: Forward Voltage Bin Definition at 160mA, T_{sp} =25°C

Bin Code	Minimum	Maximum	Unit	Condition
HE	23	24		
HF	24	25	V	I _F =160mA
HG	25	26		

Note for Table 7:

1. Bridgelux maintains a tolerance of ± 0.1V on forward voltage measurements.

^{1.} Bridgelux maintains a tolerance of \pm 7.5% on luminous flux measurements.

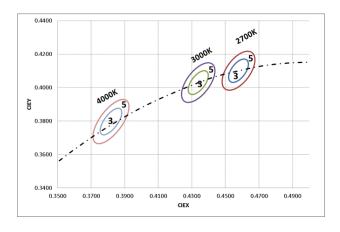
Product Bin Definitions

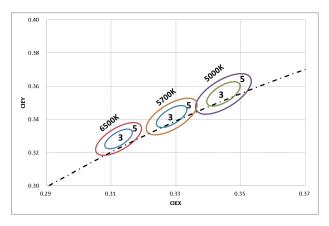
Table 8: 3- and 5-step MacAdam Ellipse Color Bin Definitions

ССТ	Colon Suppo	Cente	r Point	Majay Avia	Minor Axis	Ellipse	Color Bin	
00.	Color Space	Х	Υ	Major Axis	MINOT AXIS	Rotation Angle	COLOT BITT	
	3 SDCM	0.4578	0.4101	0.00810	0.00420	53.70	3	
2700K	5 SDCM	0.4578	0.4101	0.01350	0.00700	53.70	5	
	3 SDCM	0.4338	0.4030	0.00834	0.00408	53.22	3	
3000K	5 SDCM	0.4338	0.4030	0.01390	0.00680	53.22	5	
	3 SDCM	0.3818	0.3797	0.00939	0.00402	53.72	3	
4000K	5 SDCM	0.3818	0.3797	0.01565	0.00670	53.72	5	
	3 SDCM	0.3447	0.3553	0.00822	0.00354	59.62	3	
5000K	5 SDCM	0.3447	0.3553	0.01370	0.00590	59.62	5	
	3 SDCM	0.3287	0.3417	0.00746	0.00320	59.09	3	
5700K	5 SDCM	0.3287	0.3417	0.01243	0.00533	59.09	5	
C=2.21/	3 SDCM	0.3123	0.3282	0.00669	0.00285	58.57	3	
6500K	5 SDCM	0.3123	0.3282	0.01115	0.00475	58.57	5	

Notes for Table 8:

Figure 1: C.I.E. 1931 Chromaticity Diagram (2 Color Bin Structure, Hot-color Targeted at T_{sp} =85°C)





^{1.} Color binning at T_{sp}=85°C

^{2.} Bridgelux maintains a tolerance of \pm 0.007 on x and y color coordinates in the CIE 1931 color space.

Performance Curves

Figure 2: Drive Current vs. Voltage (T_{sp}=25°C)

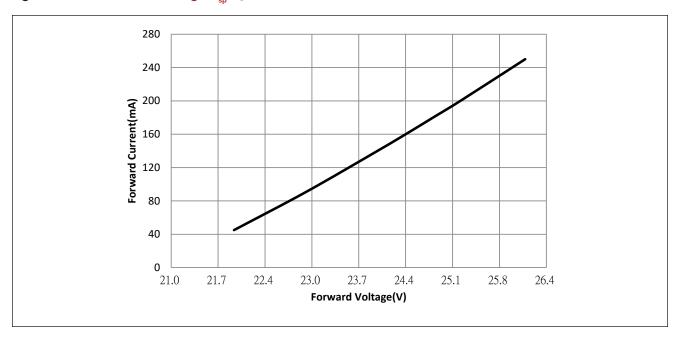
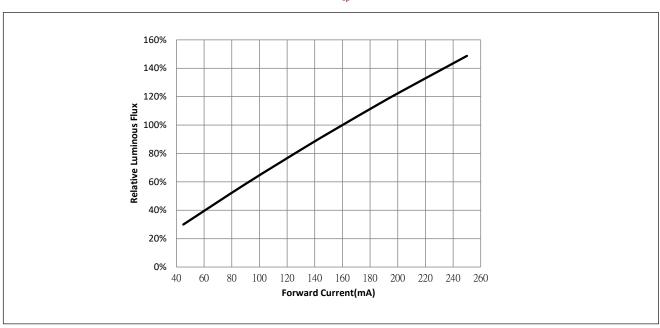


Figure 3: Typical Relative Luminous Flux vs. Drive Current (T_{sp}=25°C)



Note for Figure 3:

1. Bridgelux does not recommend driving high power LEDs at low currents. Doing so may produce unpredictable results. Pulse width modulation (PWM) is recommended for dimming effects.

Performance Curves

Figure 4: Typical Relative DC Flux vs. Solder Point Temperature

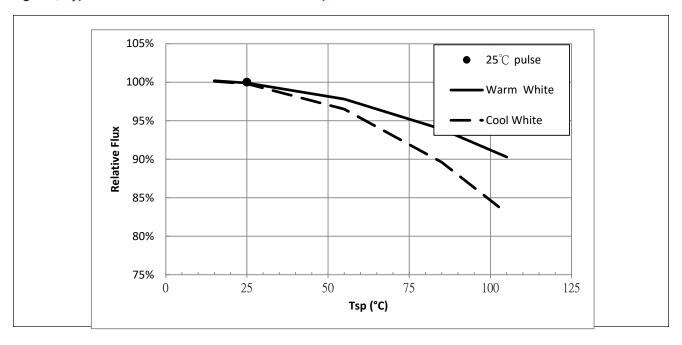
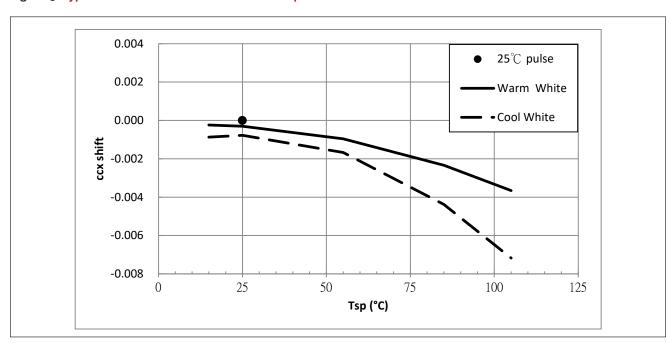


Figure 5: Typical DC ccx Shift vs. Solder Point Temperature



Notes for Figures 4 & 5:

- 1. Characteristics shown for warm white based on 3000K.
- 2. Characteristics shown for cool white based on 5700K.
- 3. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information.

Performance Curves

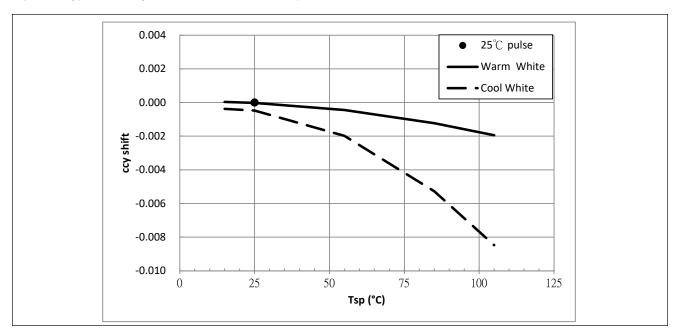
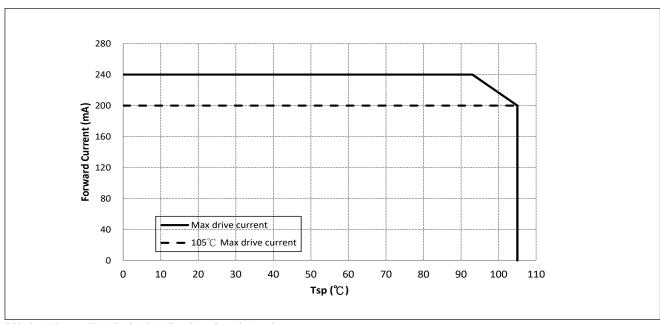


Figure 6: Typical DC ccy Shift vs. Solder Point Temperature

Notes for Figure 6:

- 1. Characteristics shown for warm white based on 3000K.
- 2. Characteristics shown for cool white based on 5700K.
- 3. For other color SKUs, the shift in color will vary. Please contact your Bridgelux Sales Representative for more information.





Typical Radiation Pattern

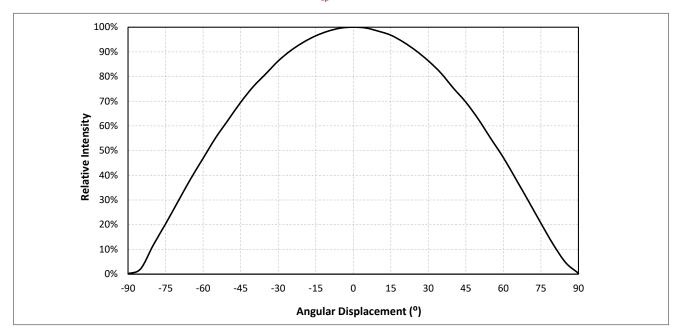
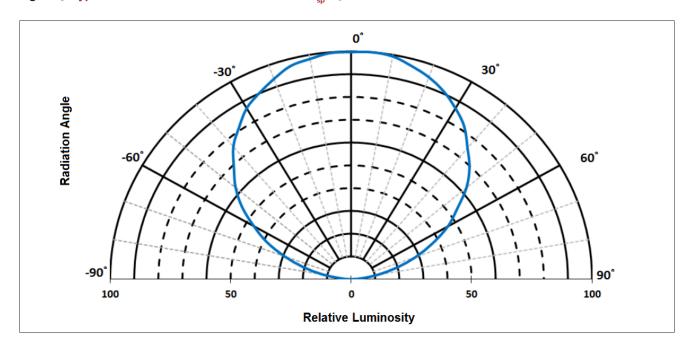


Figure 8: Typical Spatial Radiation Pattern at 160mA, T_{sp}=25°C

Notes for Figure 8:

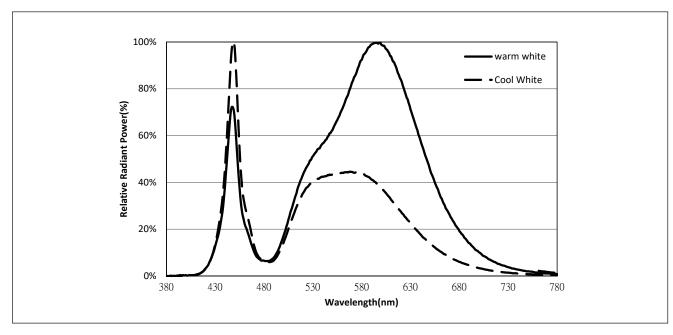
- 1. Typical viewing angle is 116°.
- 2. The viewing angle is defined as the off axis angle from the centerline where luminous intensity (Iv) is $\frac{1}{2}$ of the peak value.

Figure 9: Typical Polar Radiation Pattern at 160mA, T_{sp}=25°C



Typical Color Spectrum

Figure 10: Typical Color Spectrum

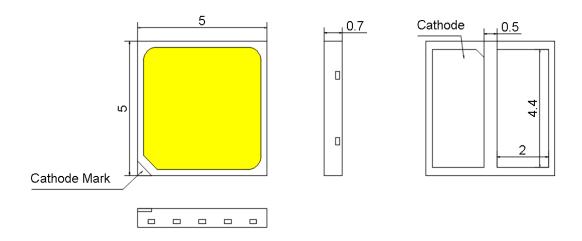


Notes for Figure 10:

- 1. Color spectra measured at nominal current for $\rm T_{\rm sp}$ = 25 $^{\circ}\rm C$
- 2. Color spectra shown for warm white is 3000K
- 3. Color spectra shown for cool white is 5700K

Mechanical Dimensions

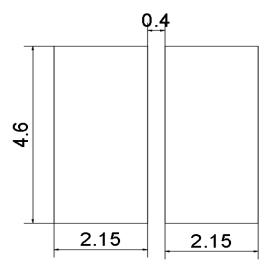
Figure 11: Drawing for SMD 5050



Notes for Figure 11:

- 1. Drawings are not to scale.
- 2. Drawing dimensions are in millimeters.
- 3. Unless otherwise specified, tolerances are \pm 0.10mm.

Recommended PCB Soldering Pad Pattern



Reliability

Table 9:Reliability Test Items and Conditions

No.	ltems	Reference Standard	Test Conditions	Drive Current	Test Duration	Units Failed/Tested
1	Moisture/Reflow Sensitivity	J-STD-020E	T _{std} = 260°C, 10sec, Precondition: 60°C, 60%RH, 168hr	-	3 reflows	0/22
2	Low Temperature Storage	JESD22-A119	T _a =-40°C	-	1000 hours	0/22
3	High Temperature Storage	JESD22-A103D	T _a = 105°C	-	1000 hours	0/22
4	Low Temperature Operating Life	JESD22-A108D	T _a =-40°C	160mA	1000 hours	0/22
5	Temperature Humidity Operating Life	JESD22-A101C	T _{sp} =85°C, RH=85%	160mA	1000 hours	0/22
6	High Temperature Operating Life	JESD22-A108D	T _{sp} =105°C	240mA	1000 hours	0/22
7	Power switching	IEC62717:2014	T _{sp} = 105°C 30 sec on, 30 sec off	240mA	30000 cycles	0/22
8	Thermal Shock	JESD22-A106B	T _a =-40°C ~100°C; Dwell : 15min; Transfer: 10sec	-	200 cycles	0/22
9	Temperature Cycle	JESD22-A104E	T _a =-40°C ~100°C; Dwell at extreme temperature: 15min; Ramp rate < 105°C/min		200 cycles	0/22
10	Electrostatic Discharge	JS-001-2012	HBM, 2KV, 1.5kΩ, 100pF, Alternately positive or negative	-	-	0/22

Passing Criteria

ltem	Symbol	Test Condition	Passing Criteria
Forward Voltage	Vf	160mA	ΔVf<10%
Luminous Flux	Fv	160mA	ΔFv<30%
Chromaticity Coordinates	(x, y)	160mA	Δu'v'<0.007

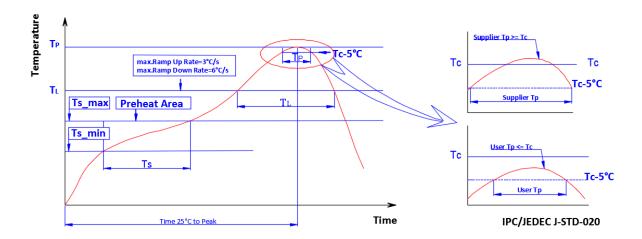
Notes for Table 9:

^{1.} Measurements are performed after allowing the LEDs to return to room temperature

^{2.} T_{sld} : reflow soldering temperature; T_a : ambient temperature

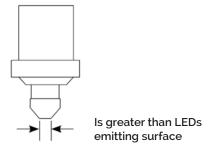
Reflow Characteristics

Figure 12: Reflow Profile



Profile Feature	Lead Free Assembly	
Temperature Min. (Ts_min)	160°C	
Temperature Max. (Ts_max)	205°C	
Time (ts) from Ts_min to Ts_max	60-150 seconds	
Ramp-Up Rate (TL to Tp)	3 °C/second	
Liquidus Temperature (TL)	220 °C	
Time (TL) Maintained Above TL	60-150 seconds	
Peak Temp(Tp)	260 °C max.	
Time (Tp) Within 5 °C of the Specified Classification Temperature (Tc)	25 seconds max.	
Ramp-Down Rate (Tp to TL)	5 °C/second max.	
Time 25 °C to Peak Temperature	10 minutes max.	

Figure 13: Pick and Place

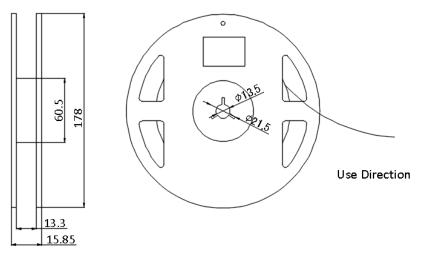


Note for Figure 13:

^{1.} When using a pick and place machine, choose a nozzle that has a larger diameter than the LED's emitting surface. Using a Pick-and-Place nozzle with a smaller diameter than the size of the LEDs emitting surface will cause damage and may also cause the LED to not illuminate.

Packaging

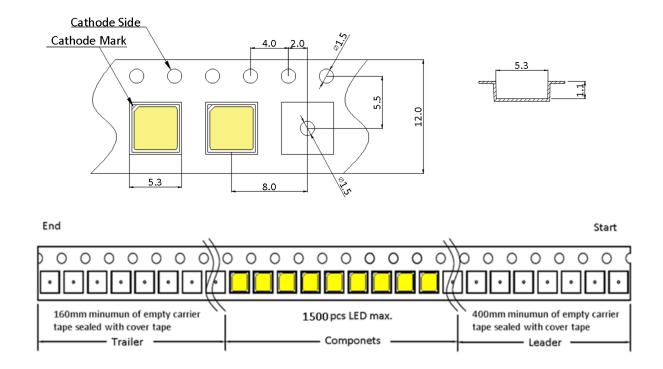
Figure 14: Emitter Reel Drawings



Note for Figure 14:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

Figure 15: Emitter Tape Drawings

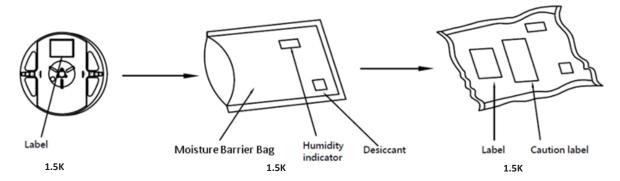


Note for Figure 15:

1. Drawings are not to scale. Drawing dimensions are in millimeters.

Packaging

Figure 16: Emitter Reel Packaging Drawings



Note for Figure 16:

1. Drawings are not to scale.

Design Resources

Please contact your Bridgelux sales representative for assistance.

Precautions

CAUTION: CHEMICAL EXPOSURE HAZARD

Exposure to some chemicals commonly used in luminaire manufacturing and assembly can cause damage to the LED emitter. Please consult Bridgelux Application Note AN51 for additional information.

CAUTION: EYE SAFETY

Eye safety classification for the use of Bridgelux SMD LED emitter is in accordance with IEC specification EN62471: Photobiological Safety of Lamps and Lamp Systems. SMD LED emitters are classified as Risk Group 2 when operated at or below the maximum drive current. Please use appropriate precautions. It is important that employees working with LEDs are trained to use them safely.

CAUTION: RISK OF BURN

Do not touch the SMD LED emitter during operation. Allow the emitter to cool for a sufficient period of time before handling. The SMD LED emitter may reach elevated temperatures such that could burn skin when touched.

CAUTION

CONTACT WITH LIGHT EMITTING SURFACE (LES)

Avoid any contact with the LES. Do not touch the LES of the emitter or apply stress to the LES (yellow phosphor resin area). Contact may cause damage to the emitter

Optics and reflectors must not be mounted in contact with the LES (yellow phosphor resin area).

Disclaimers

MINOR PRODUCT CHANGE POLICY

The rigorous qualification testing on products offered by Bridgelux provides performance assurance. Slight cosmetic changes that do not affect form, fit, or function may occur as Bridgelux continues product optimization.

STANDARD TEST CONDITIONS

Unless otherwise stated, LED emitter testing is performed at the nominal drive current.

About Bridgelux: Bridging Light and Life ™

At Bridgelux, we help companies, industries and people experience the power and possibility of light. Since 2002, we've designed LED solutions that are high performing, energy efficient, cost effective and easy to integrate. Our focus is on light's impact on human behavior, delivering products that create better environments, experiences and returns—both experiential and financial. And our patented technology drives new platforms for commercial and industrial luminaires.

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